DATA SHEET

Part No.	AN7582Z	
Package Code No.	HSIP012-P-0000E	

SEMICONDUCTOR COMPANY MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

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AN7582Z Panasonic

AN7582Z

Audio power amplifier IC

■ Features

- Dual 10 W audio power amplifier
- Built-in muting circuit
- Incorporating protection circuit

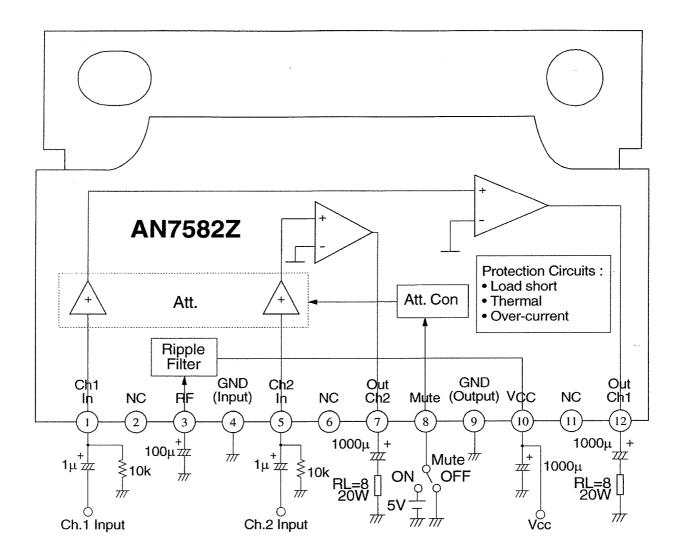
■ Application

• Low frequency amplifier

■ Package

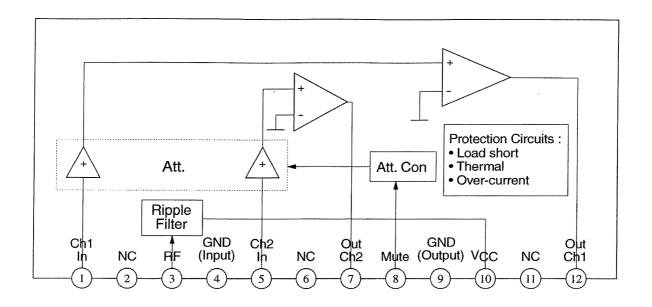
• SIL-12 pin plastic package (Power-type with fin)

■ Application Circuit Example



Note) Mute 'off ', connect to $0\ V$

■ Block Diagram



■ Pin Descriptions

Pin No.	Description	Pin No.	Description
1	Channel 1 input	7	Channel 2 output
2	Not connected	8	Mute
3	Ripple filter	9	Output GND
4	Input GND	10	V _{CC}
5	Channel 2 input	11	Not connected
6	Not connected	12	Channel 1 output

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■ Absolute Maximum Ratings

No.	Parameter	Symbol	Rating	Unit	Note
1	Supply voltage	V _{CC}	35.0	V	_
2	Supply current	I_{CC}	4.0	A	_
3	Power dissipation	P_{D}	37.5	W	*1
4	Storage temperature	T_{stg}	-55 to +150	°C	*2
5	Operating ambient temperature	T_{opr}	−25 to +75	°C	*2
6	Operating ambient atmospheric pressure	P_{opr}	$1.013 \times 10^5 \pm 0.61 \times 10^5$ (1.0 ± 0.6)	Pa (atm)	_
7	Operating constant gravity	$G_{ m opr}$	9 810 (1 000)	m/s ² (G)	_
8	Operating shock	S_{opr}	4 900 (500)	m/s ² (G)	_

Note) *1: $T_a = 75^{\circ}C$. For the independent IC without a heat sink.

■ Operating Supply Voltage Range

Parameter	Symbol Range		Unit	Note
Operating Supply Voltage Range	V _{CC}	10.0 to 32.0	V	_

^{*2:} Except for the storage temperature and operating ambient temperature, all ratings are for $T_a = 25$ °C.

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